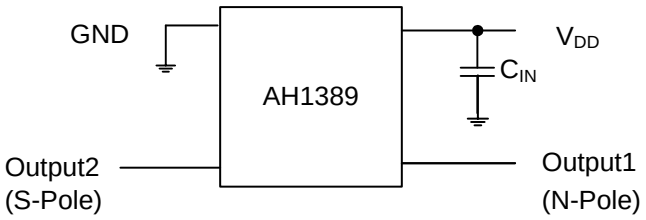
NEW PRODUCT

Typical Applications Circuit



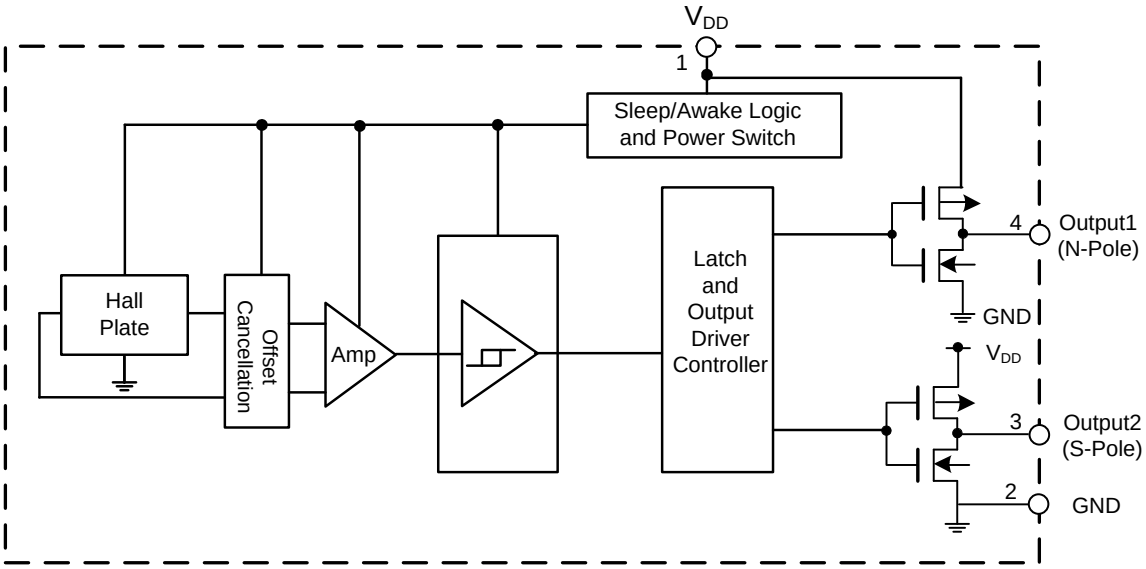
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 100nF typical and should be placed as close to the supply pin as possible.

Pin Descriptions

Package: X2-DFN1410-4

Pin Number	Pin Name	Function
1	V_{DD}	Power Supply Input
2	GND	Ground Pin
3	Output2	Output Pin(South-Pole)
4	Output1	Output Pin(North-Pole)
Pad	Pad	The center exposed pad should be tied to the GND or floating – No connection internally.

Functional Block Diagram



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Absolute Maximum Ratings (Note 5) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter		Values	Unit
V_{DD}	Supply Voltage (Note 6)		6	V
V_{DD_REV}	Reverse Supply Voltage		-0.3	V
I_{OUTPUT}	Output Current (Source and Sink)		2.5	mA
B	Magnetic Flux Density		Unlimited	
P_D	Package Power Dissipation	X2-DFN1410-4	230	mW
T_{STG}	Storage Temperature Range		-65 to +150	°C
T_J	Maximum Junction Temperature		+150	°C
ESD HBM	Human Body Model ESD Capability		8	kV

Notes: 5. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
6. The absolute maximum V_{DD} of 6V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

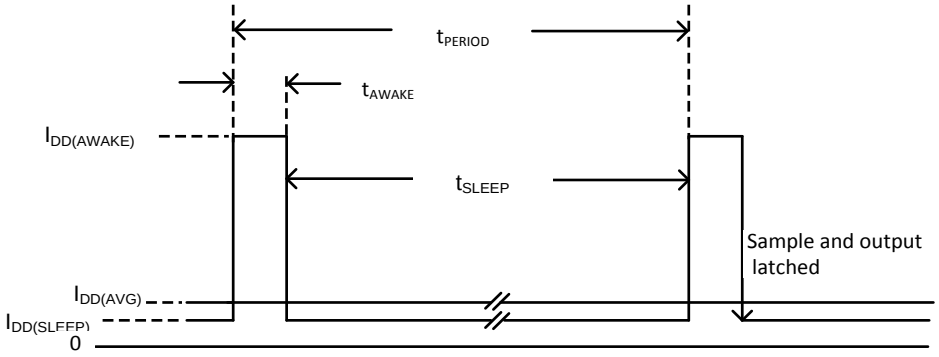
Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V_{DD}	Supply Voltage	Operating	1.6 to 3.6	V
T_A	Operating Temperature Range	Operating	-40 to +85	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OL}	Output Low Voltage (On)	I_{OUT} = 1mA	—	0.1	0.2	V
V_{OH}	Output High Voltage (Off)	I_{OUT} = -1mA	V_{DD}-0.2	V_{DD}-0.1	—	V
$I_{DD(AWAKE)}$	Supply Current	During 'Awake' Period, T_A = +25°C, V_{DD} = 3V	—	2.1	—	mA
$I_{DD(SLEEP)}$		During 'Sleep' Period, T_A = +25°C, V_{DD} = 3V	—	2.5	—	µA
$I_{DD(AVG)}$	Average Supply Current	T_A = +25°C, V_{DD} = 1.85V	—	4	8	µA
		T_A = +25°C, V_{DD} = 3.6V	—	7.2	13	µA
t_{AWAKE}	Awake Time	(Note 7)	—	50	100	µs
t_{PERIOD}	Period	(Note 7)	—	50	100	ms
D.C.	Duty Cycle	—	—	0.1	—	%

Note: 7. When power is initially turned on, the operating V_{DD} (1.6V to 3.6V) must be applied to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 100ms).



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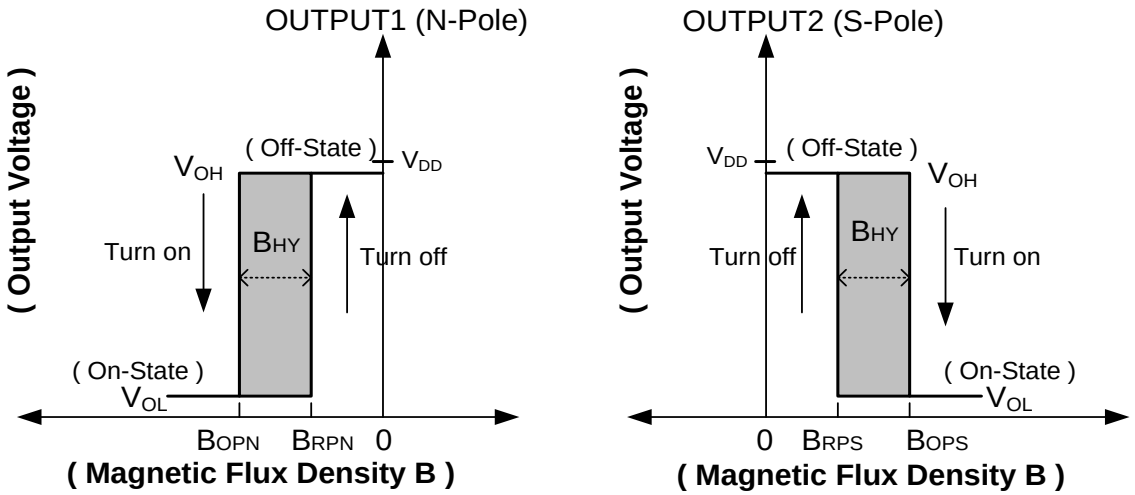
Magnetic Characteristics (Notes 8 & 9) (T_A = +25°C, V_{DD} = 1.85V, unless otherwise specified.)

Standard convention for representing the direction of magnetic field strength and flux density by positive and negative signs is as follows: Magnetic field and flux density from South pole magnet to the part marking surface of the sensor is positive. Magnetic field and flux density from the North pole magnet to the part marking surface is negative field. The positive and negative signs in below graph follow this standard convention. The positive and negative signs in the table below follow this standard convention.

(1mT=10 Gauss)

Symbol	Characteristics	Test Condition	Min	Typ	Max	Unit
B_{OPS} (South Pole to Part Marking Side) Output2	Output2 Operation Point	V_{DD} = 1.85V T_A = +25°C	14	25	32	Gauss
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	13	25	39	
B_{OPN} (North Pole to Part Marking Side) Output1	Output1 Operation Point	V_{DD} = 1.85V T_A = +25°C	-32	-25	-14	
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	-39	-25	-13	
B_{RPS} (South Pole to Part Marking Side) Output2	Output2 Release Point	V_{DD} = 1.85V T_A = +25°C	12	20	30	
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	9	20	37	
B_{RPN} (North Pole to Part Marking Side) Output1	Output1 Release Point	V_{DD} = 1.85V T_A = +25°C	-30	-20	-12	
		V_{DD} = 1.6V to 3.6V T_A = -40°C to +85°C	-37	-20	-9	
B_{HY} ($\|B_{OPX}\|$-$\|B_{RPX}\|$)	Hysteresis (Note 10)	—	1	5	—	

Notes:
8. Typical data is at T_A = +25°C, V_{DD} = 1.85V.
9. Maximum and minimum parameter values over operating temperature range are not tested in production, they are guaranteed by design, characterization and process control. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.
10. Typical and minimum hysteresis is guaranteed by design and characterization.



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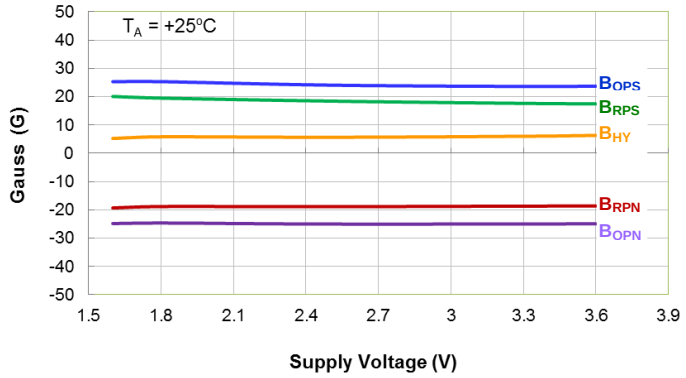
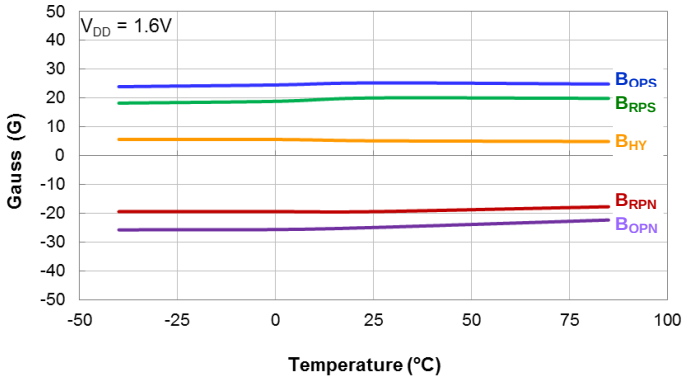
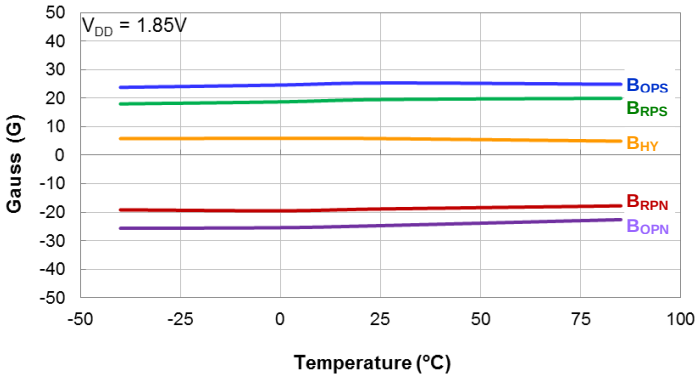
Typical Operating Characteristics



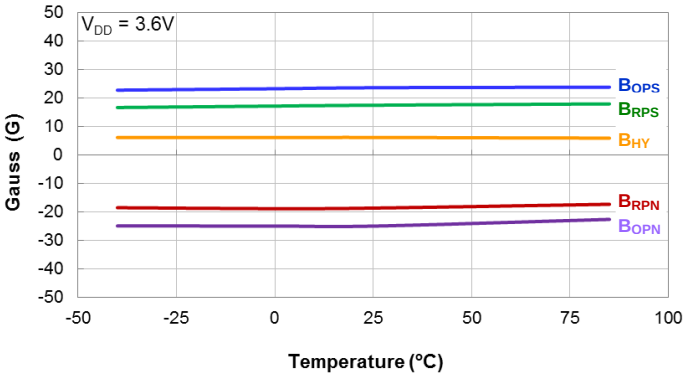
Switch Points B_{OP} and B_{RP} vs. Supply Voltage



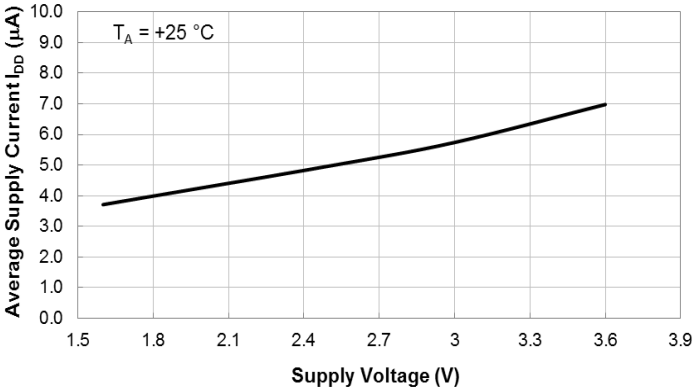
Switch Points B_{OP} and B_{RP} vs. Temperature



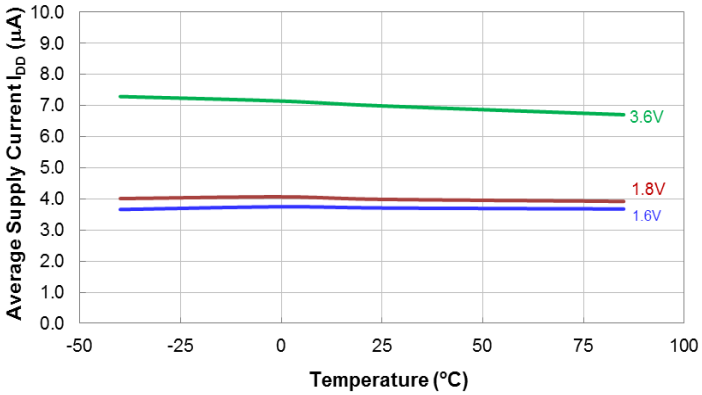
Switch Points B_{OP} and B_{RP} vs. Temperature



Switch Points B_{OP} and B_{RP} vs. Temperature



Average Supply Current vs Supply Voltage



Average Supply Current vs Temperature

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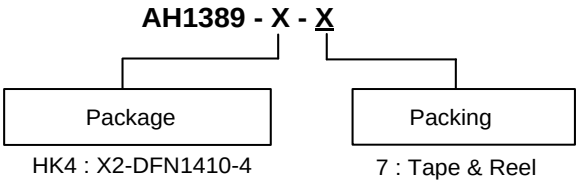
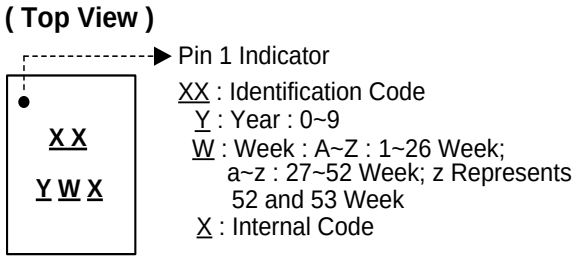
Ordering Information



Part Number	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
AH1389-HK4-7	HK4	X2-DFN1410-4	4000/Tape & Reel	-7

Marking Information

(1) Package Type: X2-DFN1410-4



Part Number	Package	Identification Code
AH1389-HK4-7	X2-DFN1410-4	FG

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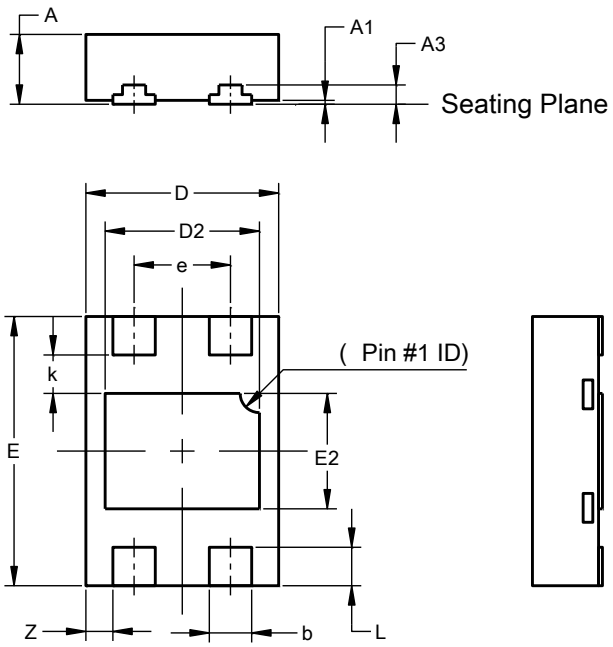
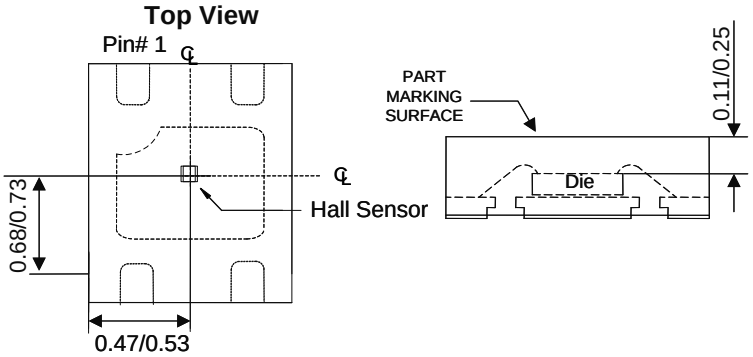
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: X2-DFN1410-4



X2-DFN1410-4			
Dim	Min	Max	Typ
A	--	0.40	0.37
A1	0.00	0.05	0.02
A3	--	--	0.100
b	0.17	0.27	0.22
D	0.95	1.05	1.00
D2	0.70	0.90	0.80
E	1.35	1.45	1.40
E2	0.50	0.70	0.60
e	0.50BSC		
k	--	--	0.20
L	0.15	0.25	0.20
z	--	--	0.14
All Dimensions in mm			



Sensor Location

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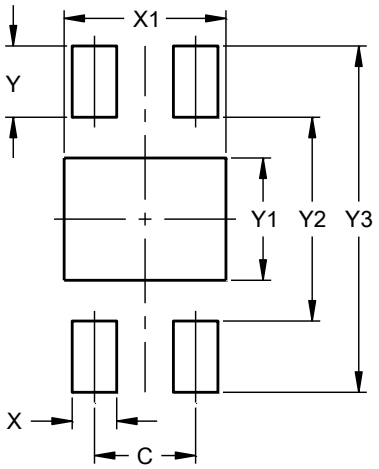
Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: X2-DFN1410-4



Dimensions	Value (in mm)
C	0.50
X	0.22
X1	0.80
Y	0.35
Y1	0.60
Y2	1.00
Y3	1.70

NEW PRODUCT

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